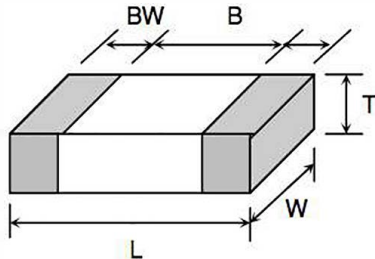


High Voltage Ceramic Chip Capacitor - CHV Series



Construction and Dimensions



Type (mm)	L (mm)	W (mm)	T (max) (mm)	B (min) (mm)	BW (min) (mm)
0603	1.60±0.10	0.80±0.10	0.95	0.4	0.15
0805	2.00±0.20	1.25±0.20	1.45	0.7	0.20
1206	3.20±0.30	1.60±0.20	1.80	1.5	0.30
1210	3.20±0.30	2.50±0.20	2.60	1.6	0.30
1808	4.60±0.30	2.00±0.20	2.20	2.5	0.30
1812	4.60±0.30	3.20±0.30	3.00	2.5	0.30
1825	4.60±0.30	6.35±0.40	3.00	2.5	0.30
2220	5.70±0.40	5.00±0.40	3.00	3.5	0.30
2225	5.70±0.40	6.35±0.40	3.00	3.5	0.30

Scope

- Cal-Chip's unique construction process ensures excellent volumetric efficiency and stability of capacitance with temperature.
- Our high voltage capacitors have extended values to those previously offered.

Features

- Special internal electrode design offers the highest voltage rating.
- Surface mount suitable for wave and reflow soldering
- High reliability
- RoHS compliant

Applications

- Suitable for LAN/WLAN interface
- Back-lighting inverter, DC-DC converters,
- Ballast, Modems and Power Supplies

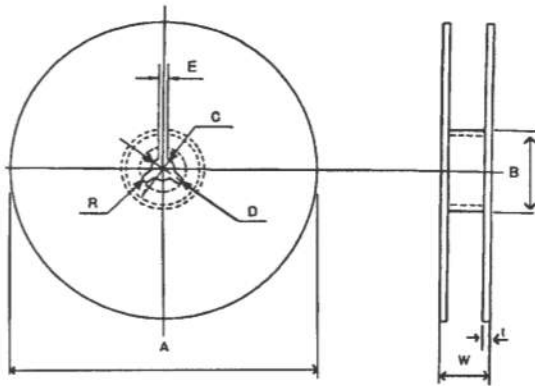
Electrical Specifications

Operation Temperature	-55°C ~ +125°C
Rating Voltage	100Vdc to 5000Vdc
Temperature Coefficient	NPO : $\leq \pm 30\text{ppm}/^\circ\text{C}$, -55°C ~ +125°C (EIA Class I)
	X7R : $\leq \pm 15\text{ppm}/^\circ\text{C}$, -55°C ~ +125°C (EIA Class II)
Dissipation Factor	NPO : $Q \leq 1000$, X7R : D.F. $\leq 2.5\%$
Insulation Resistance	10GΩ or 500/CΩ whichever is smaller
Aging	NPO: 0% , X7R: Typically 1.0% per decade of time
Dielectric Strength	100V ≤ V < 500V : 200% Rated Voltage
	500V ≤ V < 1000V : 150% Rated Voltage
	1000V ≤ V : 120% Rated Voltage

CHV	0805	N	250	103	K	X	T	D
Product Type	Size	Termination Options	Rated Voltage	Capacitance	Tolerance	Dielectric	Packaging	Packaging
	0603: 0603 0805: 0805 1206: 1206 1210: 1210 1808: 1808 1812: 1812 1825: 1825 2220: 2220 2225: 2225	N: Nickel Barrier X: Nickel Barrier/ Flex Term. A: Nickel Barrier/ Arc Protection	250: 250VDC 450: 450 500: 500 630: 630 1K0: 1KV 1K5: 1.5KV 2K0: 2KV 2K5: 2.5KV 3K0: 3KV 4K0: 4KV 5K0: 5KV	Two significant digits followed by no. of zeros. And R in place of decimal point.	B: ±1pF C: ±0.25pF D: ±0.50pF F: ±1% G: ±2% J: ±5% K: ±10% M: ±20%	C: COG X: X7R	T: 7" Reel	D: Optional 10K reel (from 0603 - 1210 size)

Packaging (Taping)

(Reel Type-Size)



Standard Reel

Unit:mm

A	B	C	D	E	W	t	R
ø178 ±2.0	ø50 min.	ø13.0 ±0.5	ø21.0 ±0.8	2.0 ±0.5	10.2 - 8mm 14.0 - 12mm +1.5	0.8 ±0.2	1.0

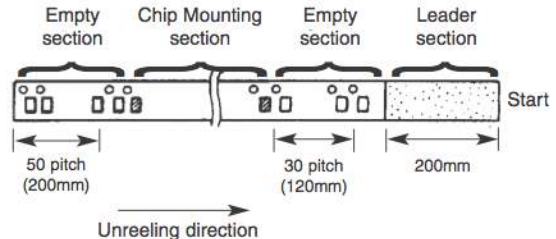
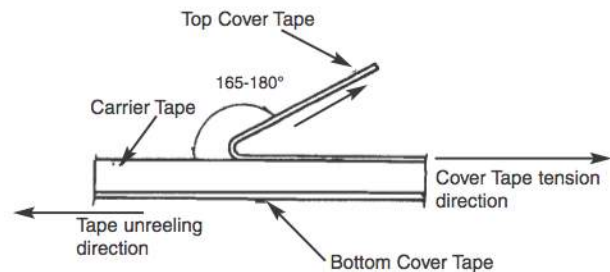
"TD" designator for optional 10/13 inch reels

Unit:mm

A	B	C	D	E	W	t	R
ø330 +2.0	ø50 min.	ø13.0 ±0.5	ø21.0 ±0.8	2.0 ±0.5	10.0 ±1.5	0.8 ±0.2	1.0

Carrier Tape (Standard)

- To peel off the cover tape by the method shown in the right figure apply a peel-off force of 20 gf - 60 gf (card board); 10 gf - 75 gf (plastic tape).
- The cover tape should not touch the top or bottom of the chip.
- If the cover tape has been peeled off it may be difficult to remove the chip due to punch-hole clearance, dirt, and debris. Make sure therefore that no paper waste will adhere to and block the absorption nozzle.
- If the cover tape has been peeled off from the top, stick it back on with a suitable adhesive.
- Follow the illustration for the start and end of the winding operation.



- Cardboard carrier tape for 0402,0603 type and 0805/1206 type

Unit: mm

Type	A	B	W	F	E	P ₁	P ₂	P ₀	D ₀	t ₁	t ₂	Mounting Hole	Std Reel Qty. 7in (10/13in)*
0402	0.7±0.2	1.3±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	ø1.5±0.1	1.1 max	1.4 max	Angular Punch Hole	10,000 (20,000)
0603	1.1±0.2	1.9±0.2											4,000 (10,000)
0805	1.65±0.2	2.4±0.2	4,000 (10,000)										
1206	2.0±0.2	3.6±0.2	4,000 (10,000)										

*quantities listed are considered as "standard" and subject to change

- Embossed plastic carrier tape for 0805/1206 type and 1210 type

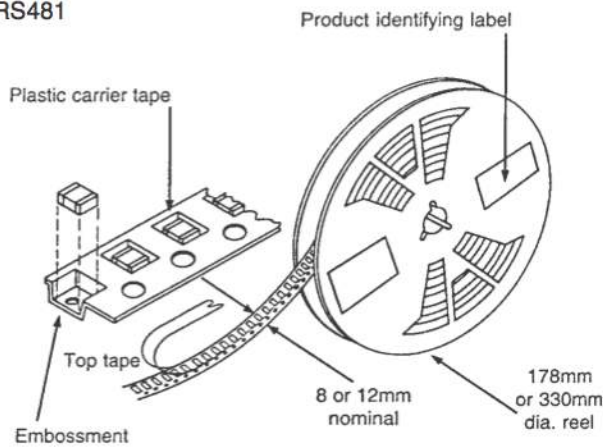
Unit:mm

Type	A	B	W	F	E	P ₁	P ₂	P ₀	D ₀	t ₁	t ₂	Mounting Hole	Std Reel Qty 7"	Optional Reel Qty (10/13")	
0805	1.45±0.2	2.3±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	ø1.5±1/0	0.6 max	2.5 max	Angular Embossed Hole	2,000	3,000	10,000
1206	2.0±0.2	3.6±0.2											2,000	3,000	10,000
1210	2.9±0.2	3.6±0.2	1,000	2,000	3,000	4,000									
1812	3.6±0.2	4.9±0.2	500	1,000	2,000										
1825	6.8±0.3	4.9±0.2	12.0±0.3	5.5±0.05	1.75±0.1	8.0±0.1	2.0±0.05	4.0±0.1	ø1.5±0.1	0.6 max	6.5 max	Angular Embossed Hole	500	1,000	1,500
2220	5.5±0.3	6.2±0.3											500	1,000	1,500
2225	6.8±0.3	6.2±0.3											500	700	1,000

*quantities listed are considered as "standard" and subject to change

■ Packaging

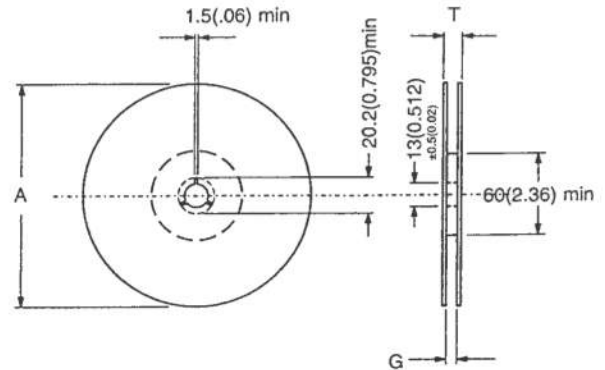
Tape and reel packing of surface mounting chip capacitors for automatic placement are in accordance with IEC286 part 3 and RS481



Peel force

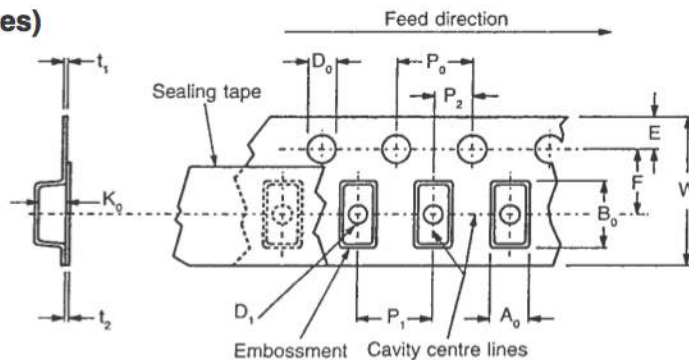
The peel force of the top sealing tape is between 0.2 and 1.0 Newton at 1800. The breaking force of the carrier and sealing tape in the direction of unreeling is greater than 10 Newtons.

Reel dimensions mm (inches)



Symbol	Description	178mm reel	330mm reel
A	Reel diameter	178(7) ±2(0.079)	330(13) max
G	Reel inside with	8.4(0.33) ±1.5(0.059)-0	12.4(0.49) ±1.5(0.059)-0
T	Reel outside with	14.4(0.56) max	18.4(0.72) max

Tape dimensions mm (inches)



Symbol	Description	8mm tape	12mm tape
A ₀	Width of cavity	Dependent on chip size to minimize rotation	
B ₀	Length of cavity		
K ₀	Depth of cavity		
W	Width of tape	8(0.315) ±0.2(0.008)	12(0.472) ±0.2(0.008)
F	Distance between drive hole centres and cavity centres	3.5(0.138) ±0.05(0.002)	5.5(0.213) ±0.05(0.002)
E	Distance between drive hole centres and tape edge	1.75(0.069) ±0.1(0.004)	
P ₁	Distance between cavity centres	4(0.156) ±0.1(0.004)	8(0.315) ±0.1(0.004)
P ₂	Axial distance between drive hole centres and cavity centres	2(0.079) ±0.05(0.002)	
P ₀	Axial distance between drive hole centres	4(0.156) ±0.1(0.004)	
D ₀	Drive hole diameter	1.5(0.059) +0.1(0.004)-0	
D ₁	Diameter of cavity piercing	1(0.039) +0.1(0.004)-0	1.5(0.059) +0.1(0.004)-0
t ₁	Embossed tape thickness	0.3(0.012) ±0.1(0.004)	0.4(0.016) ±0.1(0.004)
t ₂	Top tape thickness	0.1(0.004) max	